

## SOD-323 Plastic-Encapsulate ESD Protection Diodes

### Features

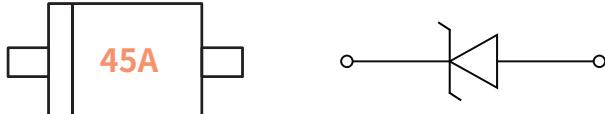
- Low leakage current
- SOD-323 surface mount package
- IEC 61000-4-2 (ESD Air):  $\pm 30\text{kV}$
- IEC 61000-4-2 (ESD Contact):  $\pm 30\text{kV}$
- IEC 61000-4-5 (Lightning 8/20 $\mu\text{s}$ ): 185A

**Reverse Working Voltage**  
4.5 V Max.  
**High capacitance**  
600 pF(Max.)

### Applications

- Mobile Phones and Accessories
- Battery Protection
- Power Supply Protection
- Hand Held Portable Applications
- Peripherals

### Function Diagram

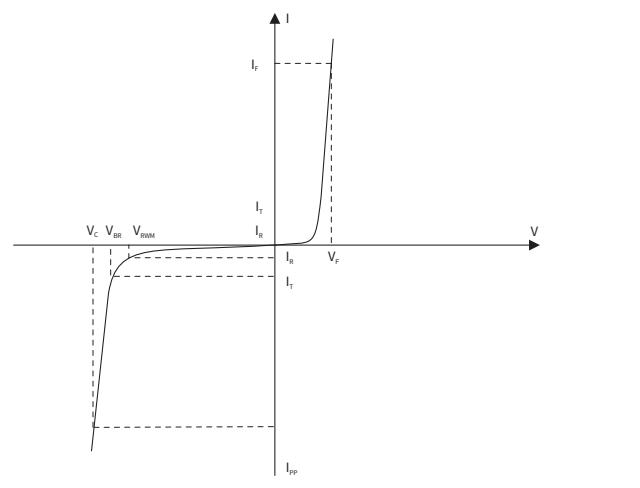


### Maximum Ratings (Ta=25°C Unless otherwise specified)

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
V <sub>ESD</sub>	Electrostatic Discharge Voltage	ESD per IEC 61000-4-2( Air )	$\pm 30$	kV
		ESD per IEC 61000-4-2( Contact )	$\pm 30$	kV
P <sub>PP</sub>	Peak Pulse Power	tp = 8/20 $\mu\text{s}$	2775	W
I <sub>PP</sub>	Rated Peak Pulse Current	tp = 8/20 $\mu\text{s}$	185	A
T <sub>J</sub>	Operating JunctionTemperature Range	—	-55 to +125	°C
T <sub>STG</sub>	Operating JunctionTemperature Range	—	-55 to +150	°C

### Electrical Parameter

SYMBOL	PARAMETER
V <sub>C</sub>	Clamping Voltage @ I <sub>PP</sub>
V <sub>BR</sub>	Breakdown Voltage @ I <sub>T</sub>
I <sub>PP</sub>	Peak Pulse Current
I <sub>T</sub>	Test Current
I <sub>R</sub>	Reverse Leakage Current @ VRWM
V <sub>RWM</sub>	Peak Reverse Working Voltage
P <sub>PP</sub>	Peak Pulse Power Dissipation
C <sub>J</sub>	Junction Capacitance @ V <sub>R</sub> =0V,f=1MHz
I <sub>F</sub>	Forward Current
V <sub>F</sub>	Forward Voltage @I <sub>F</sub>



## ● Electrical Characteristics (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	CONDITION	Min	Typ	Max	UNIT
Peak Reverse Working Voltage	V <sub>RWM</sub>	T <sub>a</sub> =25°C	—	—	4.5	V
Breakdown Voltage	V <sub>BR</sub>	I <sub>R</sub> =1.0mA, T <sub>a</sub> =25°C	4.8	—	7.0	V
Reverse Leakage Current	I <sub>R</sub>	V <sub>R</sub> =4.5V, T <sub>a</sub> =25°C	—	—	0.2	μA
Clamping Voltage	V <sub>C</sub>	I <sub>PP</sub> =20A, t <sub>p</sub> =8/20μs	—	—	7.0	V
		I <sub>PP</sub> =185A, t <sub>p</sub> =8/20μs	—	—	15	
Junction Capacitance	C <sub>J</sub>	V <sub>R</sub> =0V, f=1MHz	—	—	600	pF

## ● Ratings And Characteristics Curves (Ta=25°C Unless otherwise specified)

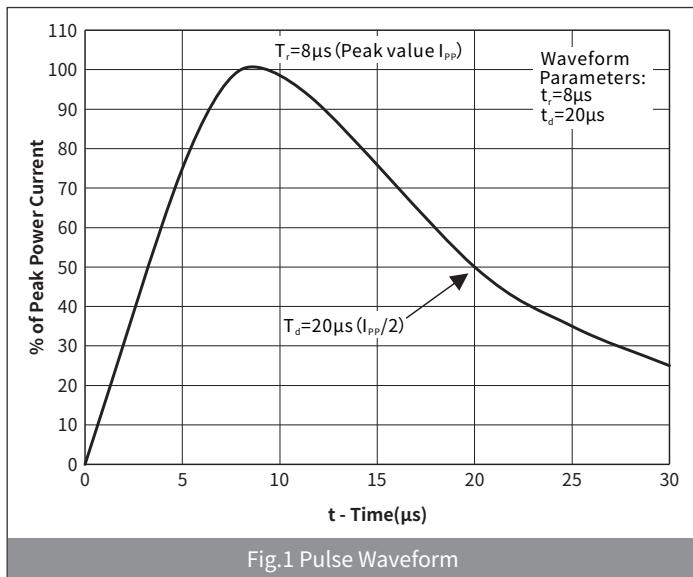


Fig.1 Pulse Waveform

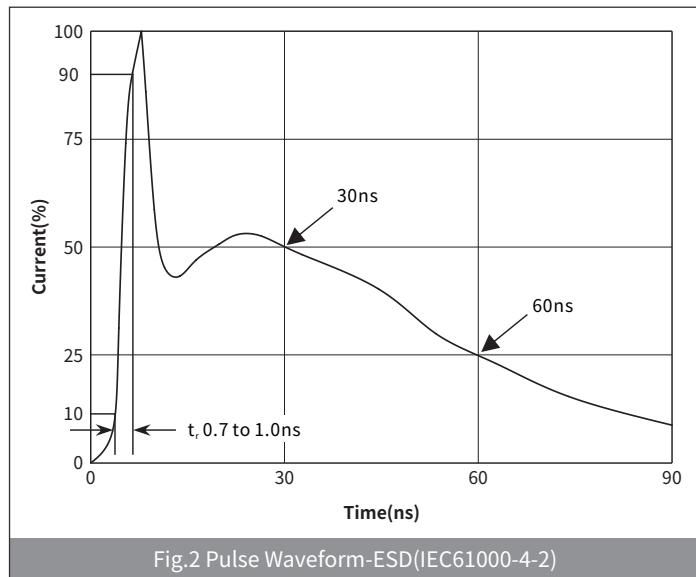


Fig.2 Pulse Waveform-ESD(IEC61000-4-2)

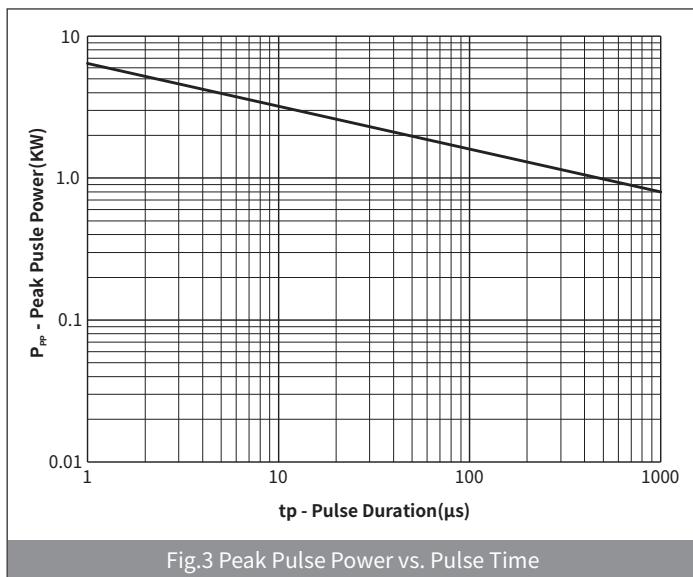


Fig.3 Peak Pulse Power vs. Pulse Time

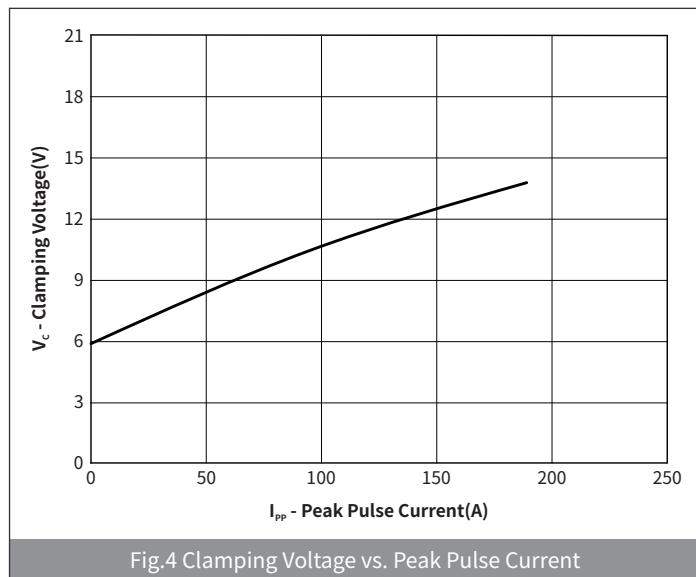
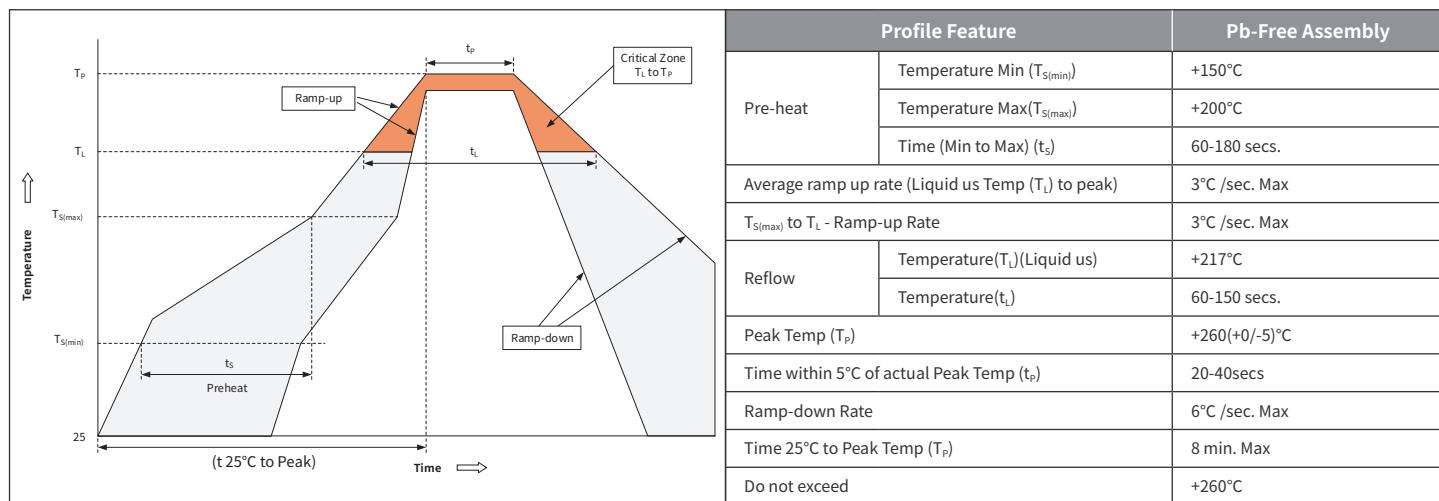


Fig.4 Clamping Voltage vs. Peak Pulse Current

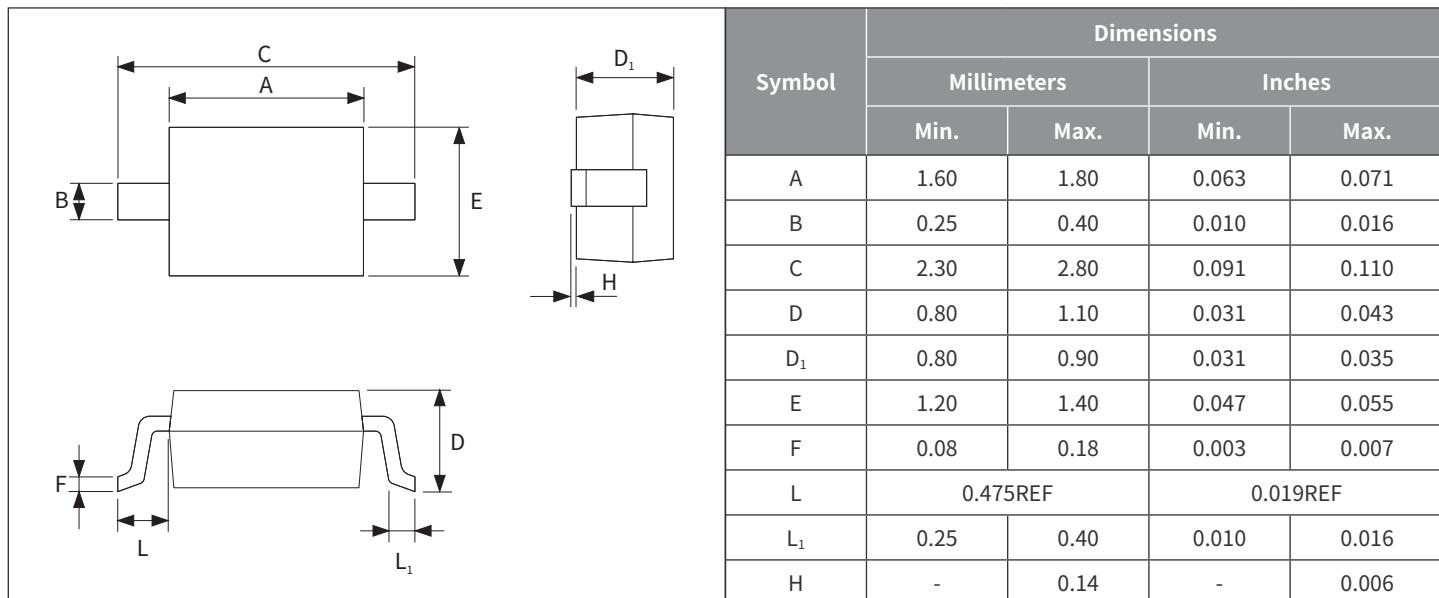
## ● Ordering Information

PREFERRED P/N	PACKAGE	SIZE(mm)	DELIVERY MODE	MPQ(PCS)
H4V5HD3U	SOD-323	2.55×1.30×0.95	7" REEL	3000

## ● Recommended Soldering Conditions



## ● Package Outline Dimensions (SOD-323)



## ● Suggested Pad Layout

